## N-Channel 20-V (D-S) MOSFET

| PRODUCT SUMMARY |  |  |  |
| :---: | :---: | :---: | :---: |
| $\mathbf{V}_{\mathbf{D S}}(\mathbf{V})$ | $\mathbf{R}_{\mathrm{DS}(\mathrm{on})}(\Omega)$ | $\mathbf{I}_{\mathbf{D}}(\mathbf{A})^{\mathbf{a}, \mathbf{e}}$ | $\mathbf{Q}_{\mathbf{g}}$ (Typ.) |
| 20 | 0.027 at $\mathrm{V}_{\mathrm{GS}}=4.5 \mathrm{~V}$ | 8 | 8.3 nC |
|  | 0.032 at $\mathrm{V}_{\mathrm{GS}}=2.5 \mathrm{~V}$ | 8 |  |
|  | 0.040 at $\mathrm{V}_{\mathrm{GS}}=1.8 \mathrm{~V}$ | 8 |  |

## FEATURES

- TrenchFET ${ }^{\circledR}$ Power MOSFET
- $100 \% \mathrm{R}_{\mathrm{g}}$ Tested
- 100 \% UIS Tested
- Compliant to RoHS Directive 2002/95/EC


## APPLICATIONS

- DC/DC Converter
- Load Switches


Ordering Information: Si4196DY-T1-E3 (Lead (Pb)-free)


N-Channel MOSFET

| ABSOLUTE MAXIMUM RATINGS $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise noted |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: |
| Parameter |  | Symbol | Limit | Unit |
| Drain-Source Voltage |  | $\mathrm{V}_{\mathrm{DS}}$ | 20 | V |
| Gate-Source Voltage |  | $\mathrm{V}_{\mathrm{GS}}$ | $\pm 8$ |  |
| Continuous Drain Current ( $\mathrm{T}_{J}=150^{\circ} \mathrm{C}$ ) | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | $\mathrm{I}_{\mathrm{D}}$ | $8^{\text {e }}$ | A |
|  | $\mathrm{T}_{\mathrm{C}}=70^{\circ} \mathrm{C}$ |  | $8^{\text {e }}$ |  |
|  | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  | $6.4{ }^{\text {b, c }}$ |  |
|  | $\mathrm{T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ |  | $5.1^{\text {b, c }}$ |  |
| Pulsed Drain Current |  | $\mathrm{I}_{\text {DM }}$ | 20 |  |
| Continuous Source-Drain Diode Current | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | Is | 3.8 |  |
|  | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  | $1.6{ }^{\text {b, c }}$ |  |
| Single Pulse Avalanche Current | $\mathrm{L}=0.1 \mathrm{mH}$ | $\mathrm{I}_{\mathrm{AS}}$ | 5 |  |
| Avalanche Energy |  | $\mathrm{E}_{\text {AS }}$ | 1.25 | mJ |
| Maximum Power Dissipation | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | $\mathrm{P}_{\mathrm{D}}$ | 4.6 | W |
|  | $\mathrm{T}_{\mathrm{C}}=70^{\circ} \mathrm{C}$ |  | 2.9 |  |
|  | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  | $2.0{ }^{\text {b, c }}$ |  |
|  | $\mathrm{T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ |  | $1.28{ }^{\text {b, c }}$ |  |
| Operating Junction and Storage Temperature Range |  | $\mathrm{T}_{\mathrm{J}}, \mathrm{T}_{\text {stg }}$ | - 55 to 150 | ${ }^{\circ} \mathrm{C}$ |

## THERMAL RESISTANCE RATINGS

| Parameter | Symbol | Typical | Maximum | Unit |  |
| :--- | :---: | :---: | :---: | :---: | :---: |
| Maximum Junction-to-Ambient ${ }^{\mathrm{b}, \mathrm{d}}$ | $\mathrm{t} \leq 10 \mathrm{~s}$ | $\mathrm{R}_{\text {thJA }}$ | 52 | 62.5 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Maximum Junction-to-Foot (Drain) | Steady State | $\mathrm{R}_{\text {thJF }}$ | 22 | 27 |  |

## Notes:

a. Based on $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$.
b. Surface Mounted on 1" x 1" FR4 board.
c. $\mathrm{t}=10 \mathrm{~s}$.
d. Maximum under Steady State conditions is $110^{\circ} \mathrm{C} / \mathrm{W}$.
e. Package limited.

| SPECIFICATIONS $\mathrm{T}_{J}=25^{\circ} \mathrm{C}$, unless otherwise noted |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Parameter | Symbol | Test Conditions | Min. | Typ. | Max. | Unit |
| Static |  |  |  |  |  |  |
| Drain-Source Breakdown Voltage | $\mathrm{V}_{\mathrm{DS}}$ | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=250 \mu \mathrm{~A}$ | 20 |  |  | V |
| $\mathrm{V}_{\mathrm{DS}}$ Temperature Coefficient | $\Delta \mathrm{V}_{\mathrm{DS}} / \mathrm{T}_{\mathrm{J}}$ | $\mathrm{I}_{\mathrm{D}}=250 \mu \mathrm{~A}$ |  | 21 |  | $\mathrm{mV} /{ }^{\circ} \mathrm{C}$ |
| $\mathrm{V}_{\text {GS(th) }}$ Temperature Coefficient | $\Delta \mathrm{V}_{\mathrm{GS}(\mathrm{th})} / \mathrm{T}_{\mathrm{J}}$ |  |  | -3.0 |  |  |
| Gate-Source Threshold Voltage | $\mathrm{V}_{\mathrm{GS}(\text { (th) }}$ | $\mathrm{V}_{\mathrm{DS}}=\mathrm{V}_{\mathrm{GS}}, \mathrm{I}_{\mathrm{D}}=250 \mu \mathrm{~A}$ | 0.4 |  | 1.0 | V |
| Gate-Source Leakage | $\mathrm{I}_{\mathrm{GSS}}$ | $\mathrm{V}_{\mathrm{DS}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}= \pm 8 \mathrm{~V}$ |  |  | $\pm 100$ | nA |
| Zero Gate Voltage Drain Current | $\mathrm{I}_{\text {DSS }}$ | $\mathrm{V}_{\mathrm{DS}}=20 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}$ |  |  | 1 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\mathrm{DS}}=20 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{~T}_{J}=55^{\circ} \mathrm{C}$ |  |  | 10 |  |
| On-State Drain Current ${ }^{\text {a }}$ | $\mathrm{I}_{\mathrm{D} \text { (on) }}$ | $\mathrm{V}_{\mathrm{DS}} \geq 5 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=4.5 \mathrm{~V}$ | 10 |  |  | A |
| Drain-Source On-State Resistance ${ }^{\text {a }}$ | $\mathrm{R}_{\text {DS(on) }}$ | $\mathrm{V}_{\mathrm{GS}}=4.5 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=8 \mathrm{~A}$ |  | 0.021 | 0.027 | $\Omega$ |
|  |  | $\mathrm{V}_{\mathrm{GS}}=2.5 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=5 \mathrm{~A}$ |  | 0.025 | 0.032 |  |
|  |  | $\mathrm{V}_{\mathrm{GS}}=1.8 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=2.5 \mathrm{~A}$ |  | 0.031 | 0.040 |  |
| Forward Transconductance ${ }^{\text {a }}$ | $\mathrm{g}_{\text {fs }}$ | $\mathrm{V}_{\mathrm{DS}}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=8 \mathrm{~A}$ |  | 28 |  | S |
| Dynamic ${ }^{\text {b }}$ |  |  |  |  |  |  |
| Input Capacitance | $\mathrm{C}_{\text {iss }}$ | $\mathrm{V}_{\mathrm{DS}}=10 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ |  | 830 |  | pF |
| Output Capacitance | $\mathrm{C}_{\text {oss }}$ |  |  | 115 |  |  |
| Reverse Transfer Capacitance | $\mathrm{C}_{\text {rss }}$ |  |  | 63 |  |  |
| Total Gate Charge | $Q_{g}$ | $\mathrm{V}_{\mathrm{DS}}=10 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=8 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=8 \mathrm{~A}$ |  | 14.5 | 22 | nC |
|  |  | $\mathrm{V}_{\mathrm{DS}}=10 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=4.5 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=8 \mathrm{~A}$ |  | 8.3 | 12.5 |  |
| Gate-Source Charge | $\mathrm{Q}_{\mathrm{gs}}$ |  |  | 1.1 |  |  |
| Gate-Drain Charge | $\mathrm{Q}_{\mathrm{gd}}$ |  |  | 1.1 |  |  |
| Gate Resistance | $\mathrm{R}_{\mathrm{g}}$ | $\mathrm{f}=1 \mathrm{MHz}$ | 0.6 | 3.0 | 6.0 | $\Omega$ |
| Turn-On Delay Time | $\mathrm{t}_{\mathrm{d}(\mathrm{on})}$ | $\begin{gathered} \mathrm{V}_{\mathrm{DD}}=10 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=2 \Omega \\ \mathrm{I}_{\mathrm{D}} \cong 5 \mathrm{~A}, \mathrm{~V}_{\mathrm{GEN}}=4.5 \mathrm{~V}, \mathrm{R}_{\mathrm{g}}=1 \Omega \end{gathered}$ |  | 8 | 16 | ns |
| Rise Time | $\mathrm{t}_{\mathrm{r}}$ |  |  | 13 | 25 |  |
| Turn-Off Delay Time | $\mathrm{t}_{\mathrm{d} \text { (off) }}$ |  |  | 33 | 60 |  |
| Fall Time | $\mathrm{t}_{\mathrm{f}}$ |  |  | 9 | 18 |  |
| Turn-On Delay Time | $\mathrm{t}_{\mathrm{d}(\mathrm{on})}$ | $\begin{gathered} \mathrm{V}_{\mathrm{DD}}=10 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=2 \Omega \\ \mathrm{I}_{\mathrm{D}} \cong 5 \mathrm{~A}, \mathrm{~V}_{\mathrm{GEN}}=8 \mathrm{~V}, \mathrm{R}_{\mathrm{g}}=1 \Omega \end{gathered}$ |  | 5 | 10 |  |
| Rise Time | $\mathrm{t}_{\mathrm{r}}$ |  |  | 12 | 24 |  |
| Turn-Off Delay Time | $\mathrm{t}_{\mathrm{d} \text { (off) }}$ |  |  | 22 | 40 |  |
| Fall Time | $\mathrm{t}_{\mathrm{f}}$ |  |  | 8 | 16 |  |
| Drain-Source Body Diode Characteristics |  |  |  |  |  |  |
| Continuous Source-Drain Diode Current | $I_{\text {S }}$ | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ |  |  | 3.8 | A |
| Pulse Diode Forward Current ${ }^{\text {a }}$ | $\mathrm{I}_{\text {SM }}$ |  |  |  | 20 |  |
| Body Diode Voltage | $\mathrm{V}_{\mathrm{SD}}$ | $\mathrm{I}_{\mathrm{S}}=5.4 \mathrm{~A}$ |  | 0.78 | 1.2 | V |
| Body Diode Reverse Recovery Time | $\mathrm{t}_{\mathrm{rr}}$ | $\mathrm{I}_{\mathrm{F}}=5.4 \mathrm{~A}, \mathrm{dl} / \mathrm{dt}=100 \mathrm{~A} / \mu \mathrm{s}, \mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ |  | 11 | 22 | ns |
| Body Diode Reverse Recovery Charge | $\mathrm{Q}_{\mathrm{rr}}$ |  |  | 4 | 8 | nC |
| Reverse Recovery Fall Time | $\mathrm{t}_{\mathrm{a}}$ |  |  | 6 |  | ns |
| Reverse Recovery Rise Time | $\mathrm{t}_{\mathrm{b}}$ |  |  | 5 |  |  |

## Notes:

a. Pulse test; pulse width $\leq 300 \mu \mathrm{~s}$, duty cycle $\leq 2 \%$.
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS $25^{\circ} \mathrm{C}$, unless otherwise noted


$\mathrm{I}_{\mathrm{D}}$ - Drain Current (A)
On-Resistance vs. Drain Current and Gate Voltage



Transfer Characteristics


Capacitance


On-Resistance vs. Junction Temperature

TYPICAL CHARACTERISTICS $25^{\circ} \mathrm{C}$, unless otherwise noted


TYPICAL CHARACTERISTICS $25^{\circ} \mathrm{C}$, unless otherwise noted



Power, Junction-to-Foot


Power, Junction-to-Ambient

* The power dissipation $P_{D}$ is based on $T_{J(\max )}=150^{\circ} \mathrm{C}$, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.


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TYPICAL CHARACTERISTICS $25^{\circ} \mathrm{C}$, unless otherwise noted


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